- Multiplexed Inputs/Outputs Provide Improved Bit Density
- Four Modes of Operations:

Hold (Store)
Shift Right

Shift Left Load Data

- Operates with Outputs Enabled or at High Z
- 3-State Outputs Drive Bus Lines Directly
- Can Be Cascaded for N-Bit Word Lengths
- SN54LS323 and SN74LS323 Are Similar But Have Synchronous Clear
- Applications:

Stacked or Push-Down Registers Buffer Storage, and Accumulator Registers

|        | GUARANTEED    | TYPICAL     |
|--------|---------------|-------------|
| TYPE   | SHIFT (CLOCK) | POWER       |
|        | FREQUENCY     | DISSIPATION |
| 'LS299 | 25 MHz        | 175 mW      |
| 'S299  | 50 MHz        | 700 mW      |

SN54LS299, SN54S299 . . . J OR W PACKAGE SN74LS299, SN74S299 . . . DW OR N PACKAGE (TOP VIEW)

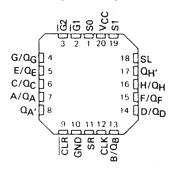
SO 1 2 19 51

G2 3 18 5L

G/QG 4 17 0H'

F/OE 5 16 H/OH

SN54LS299, SN54S299 . . . FK PACKAGE (TOP VIEW)



#### description

These Schottky TTL eight-bit universal registers feature multiplexed inputs/outputs to achieve full eight-bit data handling in a single 20-pin package. Two function-select inputs and two output-control inputs can be used to choose the modes of operation listed in the function table.

Synchronous parallel loading is accomplished by taking both function-select lines, S0 and S1, high. This places the three-state outputs in a high-impedance state, which permits data that is applied on the input/output lines to be clocked into the register. Reading out of the register can be accomplished while the outputs are enabled in any mode. A direct overriding input is provided to clear the register whether the outputs are enabled or off.

#### **FUNCTION TABLE**

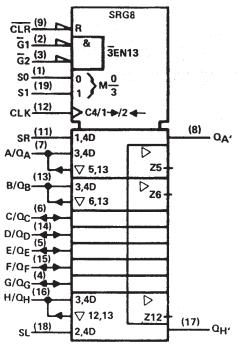
|             |     |      |           | INPL            | ITS             |     |     |      |                  |                 | IN               | PUTS/0          | OUTPU    | TS               |                  |          | OUT              | PUTS           |
|-------------|-----|------|-----------|-----------------|-----------------|-----|-----|------|------------------|-----------------|------------------|-----------------|----------|------------------|------------------|----------|------------------|----------------|
| MODE        | CLR | FUNC | ECT       |                 | TPUT<br>TROL    | CLK | SEF | RIAL | A/Q <sub>A</sub> | B/QB            | c/Q <sub>C</sub> | D/QD            | E/QE     | F/Q <sub>F</sub> | G/Q <sub>G</sub> | H/QH     | Q <sub>A</sub> , | Q <sub>H</sub> |
|             |     | S1   | <b>S0</b> | Ğ1 <sup>†</sup> | Ğ2 <sup>†</sup> |     | SL  | SR   |                  |                 |                  |                 | _        |                  |                  |          |                  |                |
|             | L   | х    | L         | L               | L               | ×   | Х   | Х    | L                | L               | L                | L               | L        | L                | L                | L        | L                | L              |
| Clear       | L   | L.   | Х         | L               | L               | ×   | X   | X    | L                | L               | L                | L               | L        | L                | L                | L.       | L                | L              |
|             | L   | Н    | н         | Х               | Х               | ×   | X   | X    | ×                | X               | X                | ×               | X        | Х                | ×                | ×        | L                | L              |
| Hold        | Н   | L    | L         | L               | ^L              | ×   | ×   | ×    | QAO              | Ово             | aco              | Q <sub>D0</sub> | QEO      | Q <sub>F0</sub>  | Q <sub>G0</sub>  | αнο      | QAO              | QHO            |
| noio        | н   | ×    | ×         | L               | L               | l L | ×   | ×    | QAO              | Q <sub>BO</sub> | $a_{co}$         |                 |          | Q <sub>F0</sub>  |                  |          | 1                |                |
| Shift Right | н   | L    | Н         | L               | L               | †   | Х   | Н    | Н                | QAn             | QBn              | Q <sub>Cn</sub> | QDn      | QEn              | QFn              | $Q_{Gn}$ | Н                | $a_{Gn}$       |
| Shirt right | н   | L    | н         | L               | L               |     | ×   | L    | L                | $Q_{An}$        | $Q_{Bn}$         | $a_{Cn}$        | $a_{Dn}$ | $\alpha_{En}$    | $Q_{Fn}$         | $Q_{Gn}$ | L                | $Q_{Gn}$       |
| Shift Left  | Н   | Н    | L         | L               | L               | 1   | Н   | ×    | QBn              | QCn             | QDn              | QEn             | QFn      | QGn              | QHn              | Н        | QBn              | Н              |
| Simil Left  | н   | Н    | L         | L               | L               | t   | L   | ×    | QBn              | $\alpha_{Cn}$   | $a_{Dn}$         | $\alpha_{En}$   | $Q_{Fn}$ | $\alpha_{Gn}$    | $Q_{Hn}$         | L        | QBn              | L              |
| Load        | Н   | Н    | Н         | Х               | ×               | 1   | Х   | Х    | а                | b               | С                | d               | e        | f                | g                | h        | а                | h              |

TWhen one or both output controls are high the eight input/output terminals are disabled to the high-impedance state; however, sequential operation or clearing of the register is not affected.

a...h = the level of the steady-state input at inputs A through H, respectively. These data are loaded into the flip-flops while the flip-flop outputs are isolated from the input/output terminals.

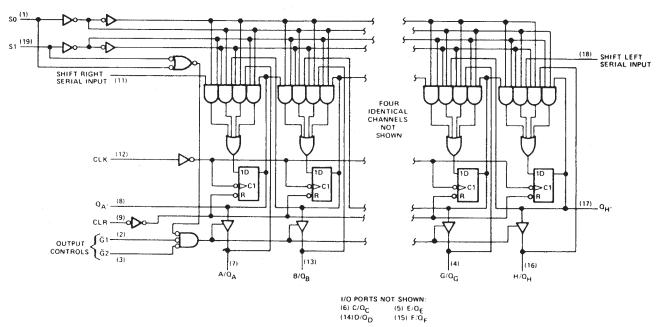


### logic symbol†



 $<sup>^\</sup>dagger$  This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for DW, J, N, and W packages.

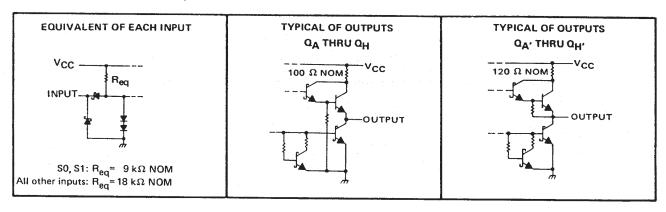
### logic diagram (positive logic)



Pin numbers shown are for DW, J, N, and W packages.



## schematics of inputs and outputs



# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| S   | upply voltage, VCC (see Note 1)      |     |    |     |     |    |    |  |  |  |  |  |  |  |    |  |  |    |     |      |     | 7 V  | , |
|-----|--------------------------------------|-----|----|-----|-----|----|----|--|--|--|--|--|--|--|----|--|--|----|-----|------|-----|------|---|
| - 1 | nput voltage                         |     |    |     |     |    | ٠. |  |  |  |  |  |  |  | ٠. |  |  |    |     |      |     | 7 V  | / |
| C   | ff-state output voltage              |     |    |     |     |    |    |  |  |  |  |  |  |  |    |  |  |    |     |      | 5.  | .5 V | , |
| (   | perating free-air temperature range: | : S | N5 | 4L  | .S2 | 99 |    |  |  |  |  |  |  |  |    |  |  | -5 | 5°( | C to | 12  | 25°C | ) |
| _   |                                      | S   | N7 | '4L | .S2 | 99 |    |  |  |  |  |  |  |  |    |  |  |    | 0   | °C 1 | o 7 | o°C  | ; |
| S   | torage temperature                   |     |    |     |     | ٠  |    |  |  |  |  |  |  |  |    |  |  | -6 | 5°( | Cto  | 15  | o°C  | ; |

NOTE 1: Voltage values are with respect to network ground terminal.

### recommended operating conditions

|  |                                      | s   | N54LS2 | 99  | s    | N74LS2 | 99   | l <u> </u> |
|--|--------------------------------------|-----|--------|-----|------|--------|------|------------|
|  |                                      | MIN | NOM    | MAX | MIN  | NOM    | MAX  | UNIT       |
| Supply voltage, VCC  |                                      | 4.5 | 5      | 5.5 | 4.75 | 5      | 5.25 | V          |
| High-level output current, IOH   | QA thru QH                           |     |        | -1  |      |        | -2.6 |            |
| The state of the s | Q <sub>A</sub> ' or Q <sub>H</sub> ' |     |        | 0.4 |      |        | -0.4 | mA         |
| Low-level output current, IOL  | QA thru QH                           |     |        | 12  |      |        | 24   |            |
|  | Q <sub>A</sub> ' or Q <sub>H</sub> ' |     |        | 4   |      |        | 8    | mA         |
| Clock frequency, fclock  |                                      | 0   |        | 20  | 0    |        | 20   | MHz        |
| Width of clock pulse, tw(clock)  | Clock high                           | 30  |        |     | 30   |        |      |            |
|  | Clock low                            | 1.8 |        |     | 10   |        |      | ns         |
| Width of clear pulse, tw(clear)  | Clear low                            | 25  |        |     | 20   |        |      | ns         |
|  | Select                               | 351 |        |     | 351  |        |      |            |
| Setup time, t <sub>SU</sub>  | High-level data <sup>†</sup>         | 201 |        |     | 201  |        |      |            |
| , <i>'</i> 50  | Low-level data <sup>†</sup>          | 20↑ |        |     | 201  |        |      | ns         |
|  | Clear inactive-state                 | 241 |        |     | 201  |        |      |            |
| Hold time, th  | Select                               | 10↑ |        |     | 101  |        |      |            |
|  | Data <sup>†</sup>                    | 3†  |        |     | 01   |        |      | ns         |
| Operating free-air temperature, TA   |                                      | -55 |        | 125 | 0    |        | 70   | °C         |

<sup>&</sup>lt;sup>†</sup> Data includes the two serial inputs and the eight input/output data lines.



## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|                  | PARAMETER                      |                                    | TEST CON                   | NITIONS!                | S   | N54LS2 | 99   | S   | N74LS2                                 | 299  | UNIT |
|------------------|--------------------------------|------------------------------------|----------------------------|-------------------------|-----|--------|------|-----|--|------|------|
|                  | TANAMETEN                      |                                    | TEST CONE                  | or rions .              | MIN | TYP‡   | MAX  | MIN | TYP <sup>‡</sup>                       | MAX  | UNIT |
| $v_{IH}$         | High-level input voltage       |                                    |                            | -                       | 2   |        |      | 2   |  |      | V    |
| VIL              | Low-level input voltage        |                                    |                            |                         |     |        | 0.7  |     |  | 8.0  | V    |
| VIK              | Input clamp voltage            |                                    | V <sub>CC</sub> = MIN,     | I <sub>I</sub> = -18 mA |     |        | -1.5 |     |  | -1.5 | V    |
| Voн              | High-level output voltage      | Q <sub>A</sub> thru Q <sub>H</sub> | V <sub>CC</sub> = MIN,     | V <sub>IH</sub> = 2 V,  | 2.4 | 3.2    |      | 2.4 | 3.1                                    |      | V    |
| VOH              | riigii-ievei output voitage    | QA' or QH'                         | VIL = VILmax,              | IOH = MAX               | 2.5 | 3.4    |      | 2.7 | 3.4                                    |      | 1 °  |
|                  |                                | Q <sub>A</sub> thru Q <sub>H</sub> | V <sub>CC</sub> = MIN,     | I <sub>OL</sub> = 12 mA |     | 0.25   | 0.4  |     | 0.25                                   | 0.4  |      |
| VOL              | Low-level output voltage       | ag ma ah                           | V <sub>IH</sub> = 2 V,     | I <sub>OL</sub> = 24 mA |     |        |      |     | 0.35                                   | 0.5  | V    |
| VOL              | Low-lever output vortage       | QA' or QH'                         | VIH - 2 V,<br>VIL = VILmax | IOL = 4 mA              |     | 0.25   | 0.4  |     | 0.25                                   | 0.4  | 1 °  |
|                  |                                | ay or all                          | AIF - AIFINGY              | IOL = 8 mA              |     |        |      |     | 0.35                                   | 0.5  | 1    |
| lozh             | Off-state output current,      | QA thru QH                         | V <sub>CC</sub> = MAX,     | V <sub>IH</sub> = 2 V,  |     |        | 40   |     |  | 40   |      |
| 'UZH             | high-level voltage applied     | ay ma ah                           | V <sub>O</sub> ≈ 2.7 V     |                         |     |        | 40   |     |  | 40   | μΑ   |
| <sup>1</sup> OZL | Off-state output current,      | Q <sub>A</sub> thru Q <sub>H</sub> | V <sub>CC</sub> = MAX,     | V <sub>IH</sub> = 2 V,  |     |        | -400 |     |  | -400 | μА   |
| .02L             | low-level voltage applied      | ад ини ан                          | V <sub>O</sub> = 0.4 V     |                         |     |        | 400  |     |  | -400 | μ~   |
|                  | Input current at maximum       | S0, S1                             |                            | V1 = 7 V                |     |        | 200  |     |  | 200  |      |
| 11               | input voltage                  | A thru H                           | V <sub>CC</sub> = MAX      | V <sub>1</sub> = 5.5 V  |     |        | 100  |     |  | 100  | μА   |
|                  | input voitage                  | Any other                          |                            | V <sub>1</sub> = 7 V    |     |        | 100  |     |  | 100  | 1    |
| 1                | High-level input current       | A thru H, SO, S1                   | V                          |                         |     |        | 40   |     |  | 40   |      |
| IН               | rngn-iever input current       | Any other                          | V <sub>CC</sub> = MAX,     | $V_1 = 2.7 \text{ V}$   |     |        | 20   |     |  | 20   | μΑ   |
| 1                | Low lovel input aussent        | S0, S1                             | V                          | V = 0.4 V               |     |        | -0.8 |     | ······································ | -0.8 |      |
| ΙΙL              | Low-level input current        | Any other                          | V <sub>CC</sub> = MAX,     | $V_1 = 0.4 V$           |     |        | -0.4 | 1   |  | -0.4 | mA   |
|                  | Short sizzuit                  | QA thru QH                         | V                          |                         | 30  |        | 130  | -30 |  | -130 | T .  |
| IOS              | Short-circuit output current 9 | QA' or QH'                         | V <sub>CC</sub> = MAX      |                         | -20 |        | -100 | -20 |  | -100 | mA   |
| Icc              | Supply current                 |                                    | V <sub>CC</sub> = MAX      |                         |     | 33     | 53   |     | 33                                     | 53   | mA   |

<sup>&</sup>lt;sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

## switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ} \text{ C}$

| PARAMETER¶       | FROM<br>(INPUT) | TO<br>(OUTPUT)                       | TEST CONDITIONS                               | MIN | TYP | MAX | UNIT |
|------------------|-----------------|--------------------------------------|---|-----|-----|-----|------|
| f <sub>max</sub> |                 |                                      | See Note 2                                    | 20  | 35  |     | MHz  |
| <sup>t</sup> PLH | CLK             | Out or Out                           | $R_1 = 2 k\Omega$ , $C_1 = 15 pF$             |     | 22  | 33  |      |
| <sup>t</sup> PHL | CLK             | Q <sub>A</sub> ' or Q <sub>H</sub> ' | N[ - 2 k32, C[ - 15 pr                        |     | 26  | 39  | ns   |
| tPHL             | CLR             | QA' or QH'                           | 7   |     | 27  | 40  | ns   |
| tPLH .           |                 | QA thru QH                           |   |     | 17  | 25  |      |
| <sup>t</sup> PHL | CLK             | QA IIII QH                           | $R_1 = 665 \Omega$ , $C_1 = 45 pF$            |     | 26  | 39  | ns   |
| <sup>t</sup> PHL | CLR             | QA thru QH                           | 11 000 32, 00 10 01                           |     | 26  | 40  | ns   |
| <sup>t</sup> PZH | G1, G2          | QA thru QH                           | 7   |     | 13  | 21  |      |
| <sup>t</sup> PZL | 01,02           | α <sub>A</sub> tinα α <sub>H</sub>   |   |     | 19  | 30  | ns   |
| <sup>t</sup> PHZ | G1, G2          | QA thru QH                           | R <sub>L</sub> = 665 Ω, C <sub>L</sub> = 5 pF |     | 10  | 20  |      |
| <sup>t</sup> PLZ | ] 31, 32        | QA IIIIO QH                          |   |     | 10  | 15  | ns   |

 $<sup>\</sup>P_{\mathsf{fmax}} \equiv \mathsf{maximum} \; \mathsf{clock} \; \mathsf{frequency}$ 



 $<sup>^{\</sup>ddagger}$ All typical values are at  $V_{CC}$  = 5 V,  $T_{A}$  = 25°C.

<sup>§</sup>Not more than one output should be shorted at a time and duration of the short-circuit should not exceed one second.

tplH = propagation delay time, low-to-high-level output.

tpHL = propagation delay time, high-to-low-level output

 $t_{PZH} = output$  enable time to high level

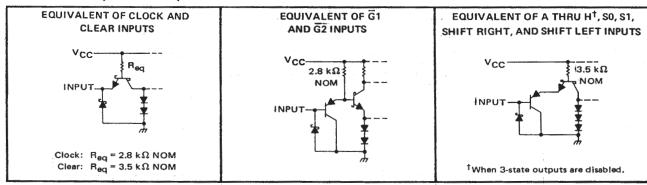
 $t_{PZL} \equiv output$  enable time to low level

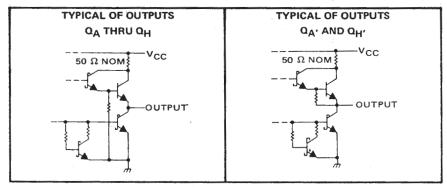
tpHZ ≡ output disable time from high level

 $t_{PLZ} \equiv output disable time from low level$ 

NOTE 2: For testing f<sub>max</sub>, all outputs are loaded simultaneously, each with C<sub>L</sub> and R<sub>L</sub> as specified for the propagation times, Load circuits and voltage waveforms are shown in Section 1.

#### schematics of inputs and outputs





### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, VCC (see Note 1)   |
|--|
| Input voltage  |
| Off-state output voltage   |
| Operating free-air temperature range: SN54S299 (See Note 1)55°C to 125°C |
| SN74S299 0 °C to 70 °C   |
| Storage temperature range65°C to 150°C                                   |

NOTE 1: Voltage values are with respect to network ground terminal.

#### recommended operating conditions

|                                    |                                    |     | N54S29 | 9    |      | N74S29 | 9    |        |
|------------------------------------|------------------------------------|-----|--------|------|------|--------|------|--------|
|                                    |                                    | MIN | NOM    | MAX  | MIN  | NOM    | MAX  | TINU   |
| Supply voltage, V <sub>CC</sub>    |                                    | 4.5 | 5      | 5.5  | 4.75 | 5      | 5.25 | V      |
| High-level output current, IOH     | QA thru QH                         |     |        | -2   |      |        | -6.5 |        |
| riigii-iever output current, 10H   | QA' or QH'                         |     |        | -0.5 |      |        | -0.5 | mA     |
| Low-level output current, IOL      | Q <sub>A</sub> thru Q <sub>H</sub> |     |        | 20   |      |        | 20   | mA     |
|                                    | QA' or QH'                         |     |        | 6    |      |        | 6    | I IIIA |
| Clock frequency, fclock            |                                    | 0   |        | 50   | 0    |        | 50   | MHz    |
| Width of clock pulse, tw(clock)    | Clock high                         | 10  |        |      | 10   |        |      |        |
|                                    | Clock low                          | 10  |        |      | 10   |        |      | ns     |
| Width of clear pulse, tw(clear)    | Clear low                          | 10  |        |      | 10   |        |      | ns     |
|                                    | Select                             | 15↑ |        |      | 15↑  |        |      |        |
| Setup time, t <sub>SU</sub>        | High-level data <sup>‡</sup>       | 7↑  |        |      | 7↑   |        |      |        |
| Setup time, tsu                    | Low-level data <sup>‡</sup>        | 5↑  |        |      | 5↑   |        |      | ns     |
|                                    | Clear inactive-state               | 10↑ |        |      | 101  |        |      |        |
| Hold time, th                      | Select                             | 5↑  |        |      | 51   |        |      |        |
| Tiold time, th                     | Data <sup>‡</sup>                  | 5↑  |        |      | 5↑   |        |      | ns     |
| Operating free-air temperature, TA |                                    | -55 |        | 125  | 0    |        | 70   | °c     |

<sup>&</sup>lt;sup>‡</sup> Data includes the two serial inputs and the eight input/output data lines.



# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|       | PARAMETER                              |                                    | TEST CON                 | DITIONS                 | MIN | TYP‡ | MAX  | UNIT  |
|-------|--|------------------------------------|--------------------------|-------------------------|-----|------|------|-------|
| VIH   | High-level input voltage               |                                    |                          |                         | 2   |      |      | V     |
| VIL   | Low-level input voltage                |                                    |                          |                         |     |      | 0.8  | V     |
| VIK   | Input clamp voltage                    |                                    | V <sub>CC</sub> = MIN,   | I <sub>I</sub> = -18 mA |     | -    | -1.2 | V     |
| Vон   | High-level output voltage              | QA thru QH                         | VCC = MIN,               | V <sub>IH</sub> = 2 V,  | 2.4 | 3.2  |      |       |
| * On  |  | QA' or QH'                         | V <sub>IL</sub> = 0.8 V, |                         | 2.7 | 3.4  |      | V     |
| VOL   | Low-level output voltage               |                                    | V <sub>CC</sub> = MIN,   | V <sub>IH</sub> = 2 V,  |     |      |      |       |
| - 01  |  |                                    | V <sub>IL</sub> = 0.8 V, | IOL = MAX               |     |      | 0.5  | ٧     |
| lozh  | Off-state output current,              | 0 45 0                             | VCC = MAX,               | V <sub>IH</sub> = 2 V,  |     |      |      |       |
| -0211 | high-level voltage applied             | Q <sub>A</sub> thru Q <sub>H</sub> | V <sub>O</sub> = 2.4 V   |                         |     |      | 100  | μА    |
| IOZL  | Off-state output current,              | 0 1 0                              |                          | V <sub>IH</sub> = 2 V,  |     |      |      |       |
| 102L  | low-level voltage applied              | Q <sub>A</sub> thru Q <sub>H</sub> | V <sub>O</sub> = 0.5 V   |                         |     |      | -250 | μА    |
| 11    | Input current at maximum input voltage |                                    | V <sub>CC</sub> = MAX,   | V <sub>I</sub> = 5.5 V  |     |      | 1    | mA    |
| чн    | High-level input current               | A thru H, S0, S1                   |                          |                         |     |      | 100  | IIIA  |
| -111  |  | Any other                          | V <sub>CC</sub> = MAX,   | V <sub>1</sub> = 2.7 V  |     |      | 50   | μА    |
|       |  | CLK or CLR                         |                          |                         |     |      | -2   | mA    |
| HL    | Low-level input current                | S0, S1                             | VCC = MAX,               | V <sub>1</sub> = 0.5 V  |     |      | -500 | μΑ    |
|       |  | Any other                          |                          | - '                     |     |      | -250 | μА    |
| los   | Short-circuit output current§          | Q <sub>A</sub> thru Q <sub>H</sub> |                          |                         | -40 |      | -100 | ····· |
| -03   | Short surface output contents          | QA' or QH'                         | V <sub>CC</sub> = MAX    | l                       | -20 |      | -100 | mA    |
| lcc   | Supply current                         |                                    | V <sub>CC</sub> = MAX    |                         |     | 140  | 225  | mA    |

 $<sup>^\</sup>dagger$  For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

# switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ} \text{ C}$

| PARAMETER¶       | FROM<br>(INPUT) | TO<br>(OUTPUT)                       | TEST CONDITIONS                      | MIN | ТҮР | MAX | UNIT |
|------------------|-----------------|--------------------------------------|--------------------------------------|-----|-----|-----|------|
| f <sub>max</sub> |                 |                                      | See Note 2                           | 50  | 70  |     | MHz  |
| <sup>†</sup> PLH | CLK             | Q <sub>A</sub> ' or Q <sub>H</sub> ' | B. = 1 kg                            |     | 12  | 20  |      |
| <sup>t</sup> PHL |                 | da or dh                             | $R_L = 1 k\Omega$ , $C_L = 15 pF$    |     | 13  | 20  | ns   |
| <sup>†</sup> PHL | CLR             | QA' or QH'                           |                                      |     | 14  | 21  | ns   |
| <sup>t</sup> PLH | CLK             | O                                    |                                      |     | 15  | 21  |      |
| <sup>t</sup> PHL |                 | QA thru QH                           |                                      |     | 15  | 21  | ns   |
| tPHL             | CLR             | QA thru QH                           | $R_L = 280 \Omega$ , $C_L = 45 pF$ . |     | 16  | 24  | ns   |
| <sup>t</sup> PZH | Ğ1, Ğ2          | 0 11 0                               | 1                                    |     | 10  | 18  |      |
| <sup>t</sup> PZL | 01,02           | QA thru QH                           |                                      |     | 12  | 18  | ns   |
| <sup>t</sup> PHZ | G1, G2          |                                      | $R_1 = 280 \Omega$ , $C_1 = 5  pF$   |     | 7   | 12  |      |
| <sup>t</sup> PLZ | G1, G2          | • QA thru QH                         |                                      |     | 7   | 12  | ns   |

<sup>¶</sup>f<sub>max</sub> = maximum clock frequency

NOTE 2: For testing  $f_{\text{max}}$ , all outputs are loaded simultaneously, each with  $C_L$  and  $R_L$  as specified for the propagation times. Load circuits and voltage waveforms are shown in Section 1.



<sup>‡</sup>All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25 ^{\circ} \text{C}$ .

<sup>§</sup> Not more than one output should be shorted at a time and duration of the short-circuit should not exceed one second.

tpLH = Propagation delay time, low-to-high-level output

tpHL = Propagation delay time, high-to-low-level output

tpzH = output enable time to high level

tpzL = output enable time to low level

tpHZ = output disable time from high level

tpLZ = output disable time from low level





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### **PACKAGING INFORMATION**

| Orderable Device |          | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan                   | Lead/Ball Finish  | MSL Peak Temp      | Op Temp (°C) | Device Marking                | Sample |
|------------------|----------|--------------|--------------------|------|----------------|----------------------------|-------------------|--------------------|--------------|-------------------------------|--------|
| 78024012A        | ACTIVE   | LCCC         | FK                 | 20   | 1              | TBD                        | (6)<br>POST-PLATE | N / A for Pkg Type | -55 to 125   | 78024012A<br>SNJ54LS<br>299FK | Sample |
| 7802401RA        | ACTIVE   | CDIP         | J                  | 20   | 1              | TBD                        | A42               | N / A for Pkg Type | -55 to 125   | 7802401RA<br>SNJ54LS299J      | Sample |
| 7802401RA        | ACTIVE   | CDIP         | J                  | 20   | 1              | TBD                        | A42               | N / A for Pkg Type | -55 to 125   | 7802401RA<br>SNJ54LS299J      | Sample |
| 7802401SA        | ACTIVE   | CFP          | W                  | 20   | 1              | TBD                        | A42               | N / A for Pkg Type | -55 to 125   | 7802401SA<br>SNJ54LS299W      | Sample |
| 7802401SA        | ACTIVE   | CFP          | W                  | 20   | 1              | TBD                        | A42               | N / A for Pkg Type | -55 to 125   | 7802401SA<br>SNJ54LS299W      | Sample |
| SN54LS299J       | ACTIVE   | CDIP         | J                  | 20   | 1              | TBD                        | A42               | N / A for Pkg Type | -55 to 125   | SN54LS299J                    | Sample |
| SN54LS299J       | ACTIVE   | CDIP         | J                  | 20   | 1              | TBD                        | A42               | N / A for Pkg Type | -55 to 125   | SN54LS299J                    | Sample |
| SN54S299J        | OBSOLETE | CDIP         | J                  | 20   |                | TBD                        | Call TI           | Call TI            | -55 to 125   |                               |        |
| SN54S299J        | OBSOLETE | CDIP         | J                  | 20   |                | TBD                        | Call TI           | Call TI            | -55 to 125   |                               |        |
| SN74LS299DW      | ACTIVE   | SOIC         | DW                 | 20   | 25             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | 0 to 70      | LS299                         | Sample |
| SN74LS299DW      | ACTIVE   | SOIC         | DW                 | 20   | 25             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | 0 to 70      | LS299                         | Sample |
| SN74LS299N       | ACTIVE   | PDIP         | N                  | 20   | 20             | Pb-Free<br>(RoHS)          | CU NIPDAU         | N / A for Pkg Type | 0 to 70      | SN74LS299N                    | Sample |
| SN74LS299N       | ACTIVE   | PDIP         | N                  | 20   | 20             | Pb-Free<br>(RoHS)          | CU NIPDAU         | N / A for Pkg Type | 0 to 70      | SN74LS299N                    | Sample |
| SN74LS299NE4     | ACTIVE   | PDIP         | N                  | 20   | 20             | Pb-Free<br>(RoHS)          | CU NIPDAU         | N / A for Pkg Type | 0 to 70      | SN74LS299N                    | Sample |
| SN74LS299NE4     | ACTIVE   | PDIP         | N                  | 20   | 20             | Pb-Free<br>(RoHS)          | CU NIPDAU         | N / A for Pkg Type | 0 to 70      | SN74LS299N                    | Sample |
| SN74S299DW       | OBSOLETE | SOIC         | DW                 | 20   |                | TBD                        | Call TI           | Call TI            | 0 to 70      |                               |        |
| SN74S299DW       | OBSOLETE | SOIC         | DW                 | 20   |                | TBD                        | Call TI           | Call TI            | 0 to 70      |                               |        |
| SN74S299DWR      | OBSOLETE | SOIC         | DW                 | 20   |                | TBD                        | Call TI           | Call TI            | 0 to 70      |                               |        |
| SN74S299DWR      | OBSOLETE | SOIC         | DW                 | 20   |                | TBD                        | Call TI           | Call TI            | 0 to 70      |                               |        |
| SN74S299N        | OBSOLETE | PDIP         | N                  | 20   |                | TBD                        | Call TI           | Call TI            | 0 to 70      |                               |        |





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| Orderable Device | Status   | Package Type | Package | Pins | Package | Eco Plan | Lead/Ball Finish | MSL Peak Temp      | Op Temp (°C) | Device Marking                | Samples |
|------------------|----------|--------------|---------|------|---------|----------|------------------|--------------------|--------------|-------------------------------|---------|
|                  | (1)      |              | Drawing |      | Qty     | (2)      | (6)              | (3)                |              | (4/5)                         |         |
| SN74S299N        | OBSOLETE | PDIP         | N       | 20   |         | TBD      | Call TI          | Call TI            | 0 to 70      |                               |         |
| SN74S299N3       | OBSOLETE | PDIP         | N       | 20   |         | TBD      | Call TI          | Call TI            | 0 to 70      |                               |         |
| SN74S299N3       | OBSOLETE | PDIP         | N       | 20   |         | TBD      | Call TI          | Call TI            | 0 to 70      |                               |         |
| SNJ54LS299FK     | ACTIVE   | LCCC         | FK      | 20   | 1       | TBD      | POST-PLATE       | N / A for Pkg Type | -55 to 125   | 78024012A<br>SNJ54LS<br>299FK | Samples |
| SNJ54LS299FK     | ACTIVE   | LCCC         | FK      | 20   | 1       | TBD      | POST-PLATE       | N / A for Pkg Type | -55 to 125   | 78024012A<br>SNJ54LS<br>299FK | Samples |
| SNJ54LS299J      | ACTIVE   | CDIP         | J       | 20   | 1       | TBD      | A42              | N / A for Pkg Type | -55 to 125   | 7802401RA<br>SNJ54LS299J      | Samples |
| SNJ54LS299J      | ACTIVE   | CDIP         | J       | 20   | 1       | TBD      | A42              | N / A for Pkg Type | -55 to 125   | 7802401RA<br>SNJ54LS299J      | Samples |
| SNJ54LS299W      | ACTIVE   | CFP          | W       | 20   | 1       | TBD      | A42              | N / A for Pkg Type | -55 to 125   | 7802401SA<br>SNJ54LS299W      | Samples |
| SNJ54LS299W      | ACTIVE   | CFP          | W       | 20   | 1       | TBD      | A42              | N / A for Pkg Type | -55 to 125   | 7802401SA<br>SNJ54LS299W      | Samples |
| SNJ54S299FK      | OBSOLETE | LCCC         | FK      | 20   |         | TBD      | Call TI          | Call TI            | -55 to 125   |                               |         |
| SNJ54S299FK      | OBSOLETE | LCCC         | FK      | 20   |         | TBD      | Call TI          | Call TI            | -55 to 125   |                               |         |
| SNJ54S299J       | OBSOLETE | CDIP         | J       | 20   |         | TBD      | Call TI          | Call TI            | -55 to 125   |                               |         |
| SNJ54S299J       | OBSOLETE | CDIP         | J       | 20   |         | TBD      | Call TI          | Call TI            | -55 to 125   |                               |         |
| SNJ54S299W       | OBSOLETE | CFP          | W       | 20   |         | TBD      | Call TI          | Call TI            | -55 to 125   |                               |         |
| SNJ54S299W       | OBSOLETE | CFP          | W       | 20   |         | TBD      | Call TI          | Call TI            | -55 to 125   |                               |         |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.





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**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above. **Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF SN54LS299, SN54S299, SN74LS299, SN74S299:

Catalog: SN74LS299, SN74S299

Military: SN54LS299, SN54S299

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

## 14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

# N (R-PDIP-T\*\*)

# PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.





SOIC



- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
- 5. Reference JEDEC registration MS-013.



SOIC



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOIC



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



# W (R-GDFP-F20)

# CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.

  D. Index point is provided on cap for terminal identification only.

  E. Falls within Mil—Std 1835 GDFP2—F20



# FK (S-CQCC-N\*\*)

# LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004



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